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HD74HC4538

Dual Precision Retriggerable/Resettable Monostable Multivibrators

REJ03D0654-0200 (Previous ADE-205-543) Rev.2.00 Mar 30, 2006

Description

Each multivibrator features both a negative, A, and a positive, B, transition triggered input, either of which can be used as an inhibit input. Also included is a clear input that when taken low resets the one short. The HD74HC4538 is retriggerable. That is, it may be triggered repeatedly while their outputs are generating a pulse and the pulse will be extended.

Pulse width stability over a wide range of temperature. The output pulse equation is simply: $t_w = 0.7$ (R) (C).

Features

• High Speed Operation: t_{pd} (A or B to Y) = 22 ns typ ($C_L = 50 \text{ pF}$)

• High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2$ to 6 V

Low Input Current: 1 μA max
 Low Quiescent Supply Current

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC4538P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	_
HD74HC4538FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)
HD74HC4538RPEL	4HC4538RPEL SOP-16 pin (JEDEC)		RP	EL (2,500 pcs/reel)

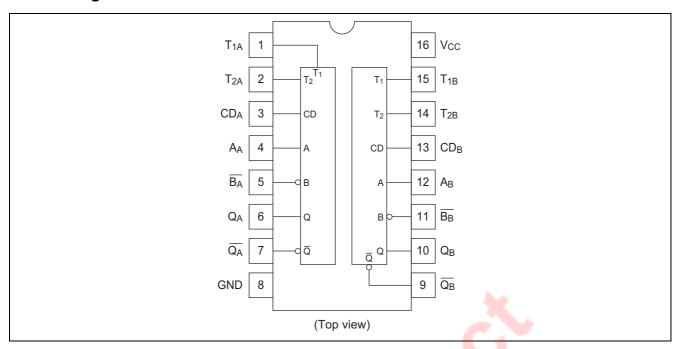
Note: Please consult the sales office for the above package availability.

Function Table

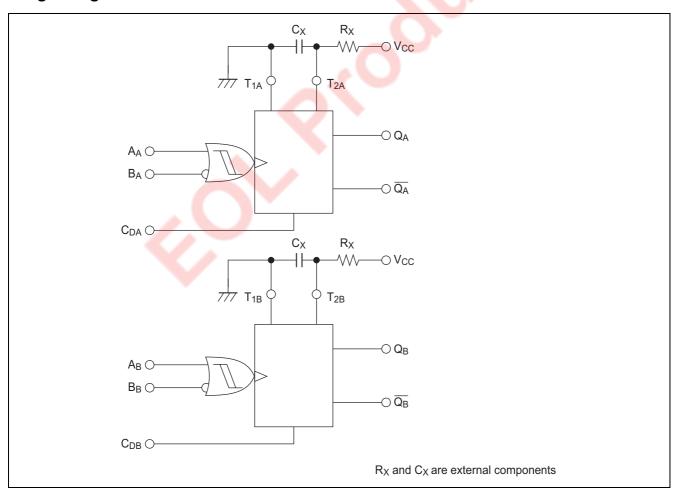
	Inputs	Outputs				
C _D	Α	В	Q Q			
L	X	X	L	Н		
Н	L	_	JL	T		
Н		Н	JL	T		
Н	Н	_	Not triggered			
Н	Γ	L	Not triggered			

X: Irrelevant

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5 to +7.0	V
Input voltage	Vin	-0.5 to V _{CC} + 0.5	V
Output voltage	Vout	-0.5 to V _{CC} + 0.5	V
DC input diode current	I _{IK}	±20	mA
DC input diode current pin 2, 14	I _{IK}	±30	mA
DC output diode current	I _{OK}	±20	mA
DC current drain per pin	lout	±25	mA
DC current drain per V _{CC} , GND	I _{CC} , I _{GND}	±50	mA
Power dissipation per package	P _T	500	mW
Storage temperature	Tstg	-65 to +150	°C

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	2 to 6	V	
Input / Output voltage	V _{IN} , V _{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	<u> </u>
		0 to 1000		V _{CC} = 2.0 V
Input rise / fall time*1	t _r , t _f	0 to 500	ns	V _{CC} = 4.5 V
		0 to 400		V _{CC} = 6.0 V

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

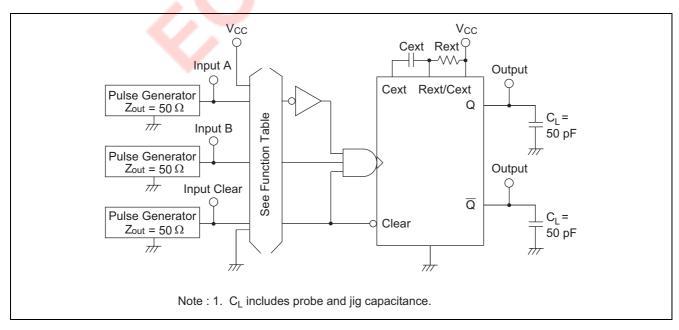
			Т	a = 25°	С	Ta = -40	to+85°C		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Input voltage	V_{IH}	2.0	1.5	7	_	1.5	_	V	
		4.5	3.15	_	P	3.15	_		
		6.0	4.2	_	_	4.2	_		
	V_{IL}	2.0	-		0.5	_	0.5	V	
		4.5	1-1	_	1.35	_	1.35		
		6.0	_	_	1.8	_	1.8		
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9	_	V	Vin = V_{IH} or V_{IL} $I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_		
		6.0	5.9	6.0	_	5.9	_		
		4.5	4.18	_	_	4.13	_		$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_		$I_{OH} = -5.2 \text{ mA}$
	V _{OL}	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL} _{OL} = 20 \mu A$
		4.5	_	0.0	0.1	_	0.1		
		6.0	_	0.0	0.1	_	0.1		
		4.5	_	_	0.26	_	0.33		$I_{OL} = 4 \text{ mA}$
		6.0	_	_	0.26	_	0.33		$I_{OL} = 5.2 \text{ mA}$
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V _{CC} or GND
Quiescent supply	Icc	6.0	_	_	130	_	220	μΑ	Vin = V _{CC} or GND,
current									$Q_A = Q_B = GND$, lout = 0 μA
(standby state)									
Current drain	Icc	6.0	_	_	130	_	220	μΑ	$Vin = V_{CC} \text{ or GND},$
(active state)									$Q_A = Q_B = V_{CC}$
									Pin 2, 14 = 0.5 V _{CC}

Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

			Т	a = 25°	С	Ta = -40	to +85°C		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay	t _{PLH}	2.0	_	_	235	_	295	ns	A or B to Q
time		4.5	_	22	47	_	59		
		6.0	_	_	40	_	50		
	t _{PHL}	2.0	_	_	260	_	325	ns	A or B to Q
		4.5	_	23	52	_	65		
		6.0	_	_	44	_	55		
	t _{PHL}	2.0	_	_	235	_	295	ns	C _D to Q
		4.5	_	17	47	_	59		
		6.0	_	_	40	_	50		
	t _{PLH}	2.0	_	_	235	_	295	ns	C _D to $\overline{\mathbb{Q}}$
		4.5	_	_	47	_	59		
		6.0	_	_	40	_	50		
Pulse width	t _w	2.0	80	_	_	100	_	ns	A, B, C _D
		4.5	16	_	_	20	_		
		6.0	14	_	_	17	_	1	
Output pulse width	t _{WQ}	3.0	_	150	_	_	_	ns	$R_X = 1 \text{ k}\Omega$, $C_X = 12 \text{ pF}$
		5.0	_	100	_	_	_		
		3.0	_	_	_	_	- 1	μs	$R_X = 10 \text{ k}\Omega, C_X = 100 \text{ pF}$
		5.0	_	1.3	_	- (<i>→</i> .		
		3.0	_	_	_	_	7-7	μs	$R_X = 10 \text{ k}\Omega, C_X = 1000 \text{ pF}$
		5.0	_	9	_	- (-		
		3.0	_	_	_			μs	$R_X = 10 \text{ k}\Omega, C_X = 10000 \text{ pF}$
		5.0	_	70	-		_		
Pulse width match	Δt_{WQ}	5.0	_	±0.1	_		_	%	$R_X = 10 \text{ k}\Omega, C_X = 1000 \text{ pF}$
between circuits in the same package									

Caution in use: In order to prevent any malfunctions due to noise, connect a high frequency performance capacitor between V_{CC} and GND, and keep the wiring between the External components and Cext, Rext/Cext pins as short as possible.

Test Circuit



Circuit Operation

Figure 3 shows the HC4538 configured in the retriggerable mode. Briefly, the device operates as follows (refer to figure 1): In the quiescent state, the external timing capacitor, C_X , is charged to V_{CC} . When a trigger occurs, the Q output goes high and C_X discharges quickly to the lower references voltage (Vref Lower $\approx 1/3~V_{CC}$). C_X then charges, through R_X , back up to the upper reference voltage (Vref Upper $\approx 2/3~V_{CC}$), at which point the one-shot has timed out and the Q output goes low.

The following, more detailed description of the circuit operation refers to both the function diagram (figure 1) and the timing diagram (figure 2)

Quiescent State

In the quiescent state, before an input trigger appears; the output latch is high and the reset latch is high (1 in figure 2). Thus the Q output (pin 6 or 10) of the monostable multivibrator is low (2 figure 2).

The output of the trigger-control circuit is low (3), and transistors M1, M2, and M3 are turned off. The external timing capacitor, C_X , is charged to V_{CC} (4), and the upper reference circuit has a low output (5). Transistor M4 is turned on and analog switch S1 is turned off. Thus the lower reference circuit has V_{CC} at the noninverting input and a resulting low output (6).

In addition, the output of the trigger-control reset circuit is low.

Trigger Operation

The HC4538 is triggered by either a rising-edge signal as input A (7) or a falling-edge signal at input B (8), with the unused trigger input and the Reset input held at the voltage levels shown in the Function Table. Either trigger signal will cause the output of the trigger-control circuit to go high (9). The trigger-control circuit going high simultaneously initiates three events. First, the output latch goes low, thus taking the Q output of the HC4538 to a high state (10). Second, transistor M3 is turned on, which allows the external timing capacitor, C_X , to rapidly discharge toward ground (11). (Note that the voltage across C_X appears at the input of the upper reference circuit comparator). Third, transistor M4 is turned off and analog switch S1 is turned on, thus allowing the voltage across C_X to also appear at the input of the lower reference circuit comparator.

When C_X discharges to the reference voltage of the lower reference circuit (12), the outputs of both reference circuits will be high (13). The trigger-control circuit flip-flop to a low state (14). This turns transistor M3 off again, allowing C_X to begin to charge back up toward V_{CC} , with a time constant $t = R_X C_X$ (15). In addition, transistor M4 is turned on and analog switch S1 is turned off. Thus a high voltage level is applied to the input of the lower reference circuit comparator, causing its output to go low (16). The monostable multivibrator may be retriggered at any time after the trigger-control circuit goes low.

When C_X charges up to the reference voltage of the upper reference circuit (17), the output of the upper reference circuit goes low (18). This causes the output latch to toggle, taking the Q output of the HC4538 to a low state (19), and completing the time-out cycle.

Reset Operation

A low voltage applied to the Reset pin always forces the Q output of the HC4538 to a low state.

The timing diagram illustrates the case in which reset occurs (20) while C_X is charging up toward the reference voltage of the upper reference circuit (21). When a reset occurs, the output of the reset latch goes low (22), turning on transistor M1. Thus C_X is allowed to quickly charge up to V_{CC} (23) to await the next trigger signal.

Retrigger Operation

When used in the retriggerable mode (figure 3), the HC4538 may be retriggered during timing out of the output pulse at any time after the trigger-control circuit flip-flop has been reset (24). Because the trigger-control circuit flip-flop resets shortly after C_X has discharged to the reference voltage of the lower reference circuit (25), the minimum retrigger time, t_{rr} (Switching Waveform 1) is a function of internal propagation delays and the discharge time of C_X :

Figure 4 shows the device configured in the non-retriggerable mode.



Power-Down Considerations

Large values of C_X may cause problems when powering down the HC4538 because of the amount of energy stored in the capacitor. When a system containing this device is powered down, the capacitor may discharge from V_{CC} through the input protection diodes at pin 2 or pin 14. Current through the protection diodes must be limited to 30 mA; therefore, the turn-off time of the V_{CC} power supply must not be faster than $t = V_{CC} \cdot C_X / (30 \text{ mA})$. For example, if $V_{CC} = 5 \text{ V}$ and $C_X = 15 \text{ µF}$, the V_{CC} supply must turn off no faster than $t = (5 \text{ V}) \cdot (15 \text{ µF}) / 30 \text{ mA} = 2.5 \text{ ms}$. This is usually not a problem because power supplies are heavily filtered and cannot discharge at this rate.

When a more rapid decrease of V_{CC} to zero voltage occurs, the HC4538 may sustain damage. To avoid this possibility, use an external clamping diode.

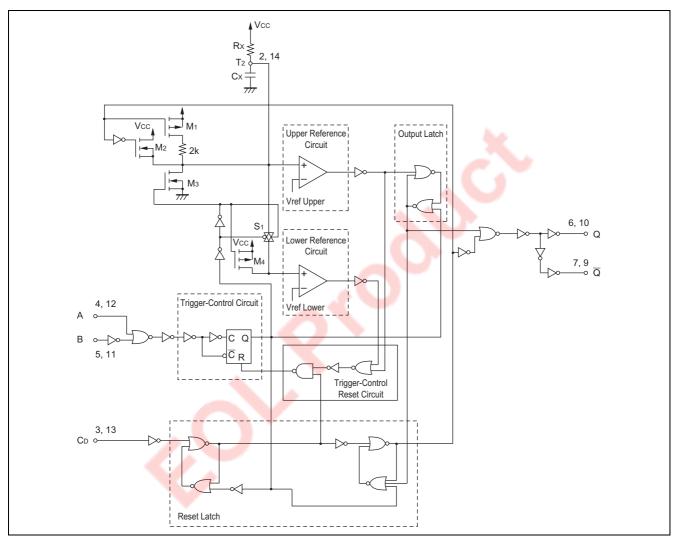


Figure 1. Function Diagram

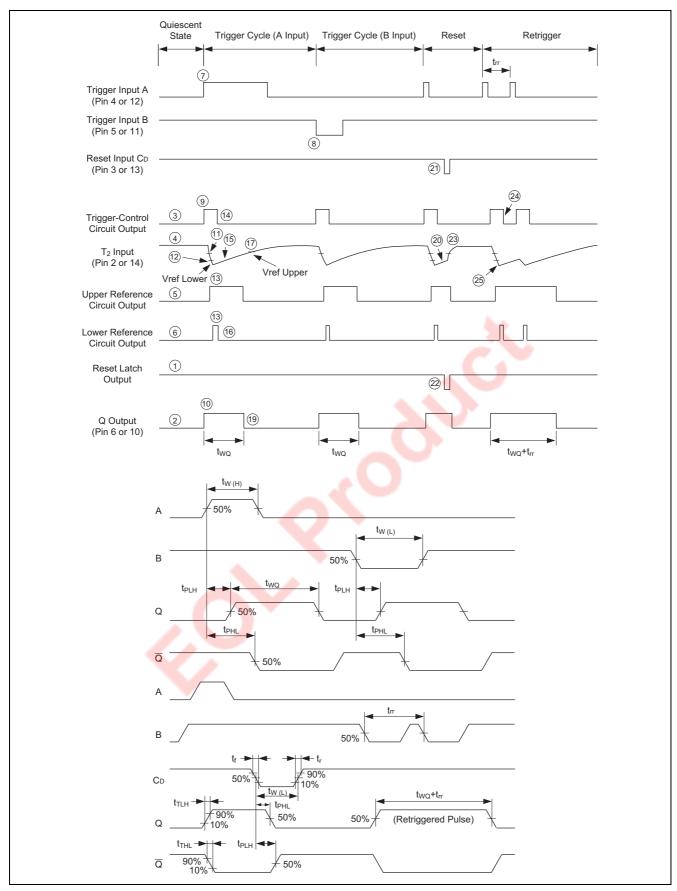


Figure 2. Timing Diagram

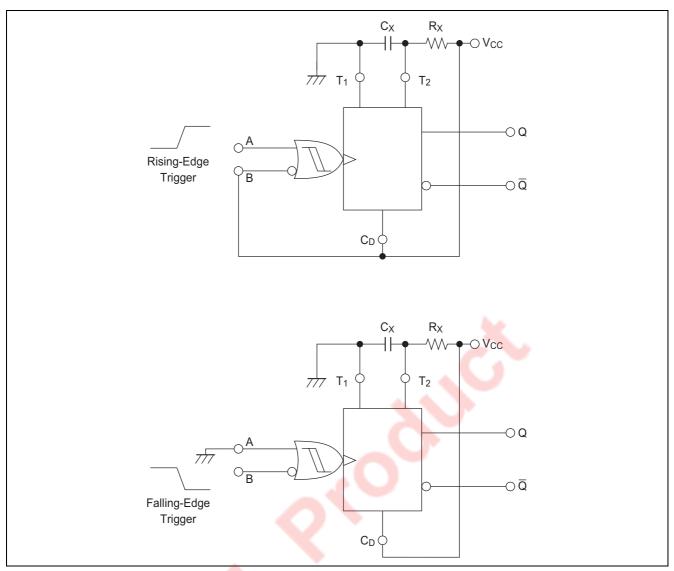


Figure 3. Retriggerable Monostable Circuitry

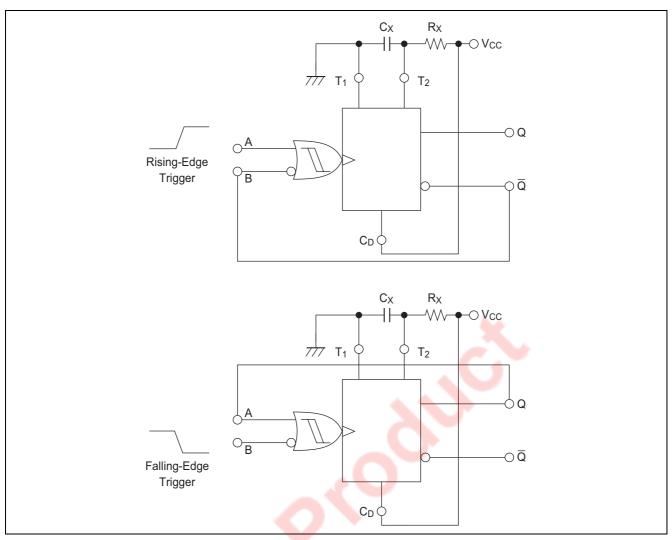
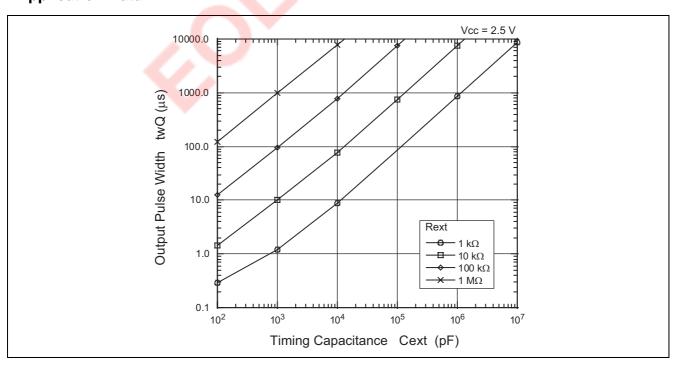
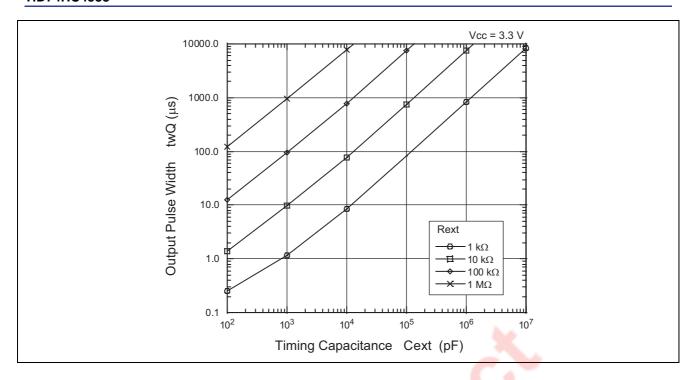
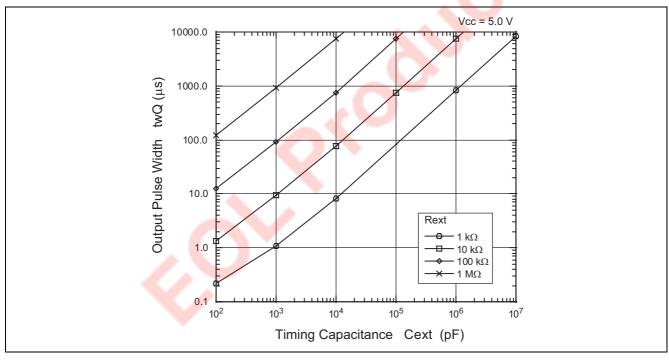


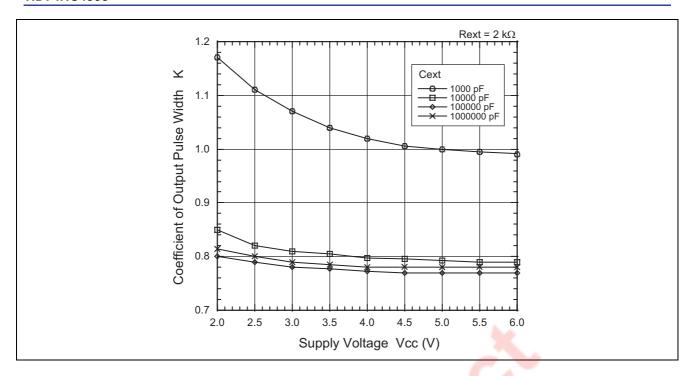
Figure 4. Nonritriggerable Monostable Circuitry

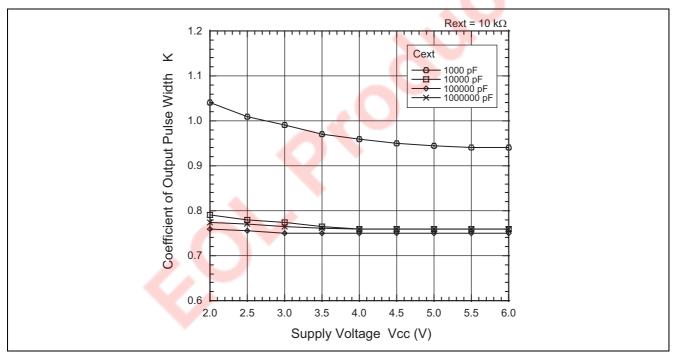
Application Data



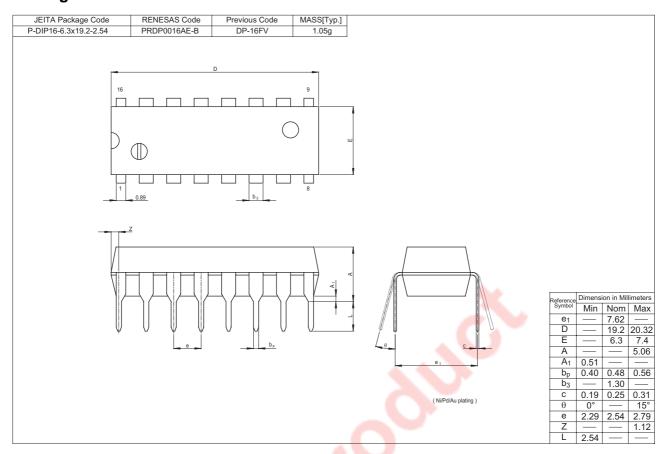


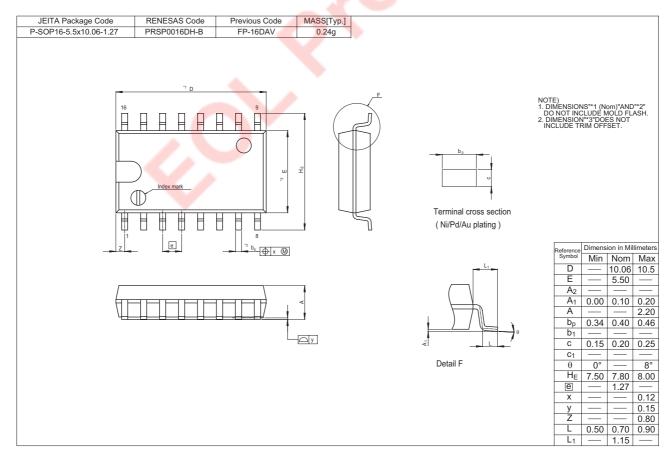


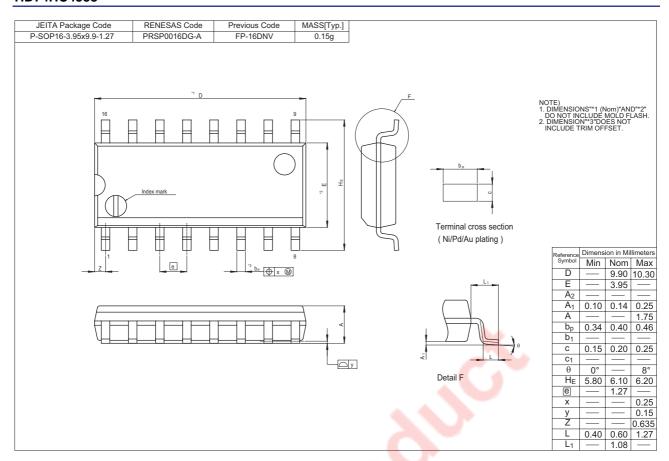




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